## 2SB0942 (2SB942), 2SB0942A (2SB942A)

## Silicon PNP epitaxial planar type

## For low-frequency power amplification

Complementary to 2SD1267, 2SD1267A
Features

- High forward current transfer ratio $\mathrm{h}_{\mathrm{FE}}$ which has satisfactory linearity
- Large collector-emitter saturation voltage $\mathrm{V}_{\mathrm{CE}(\text { sat })}$
- Full-pack package which can be installed to the heat sink with one screw
- Absolute Maximum Ratings $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$

| Parameter |  | Symbol | Rating | Unit |
| :---: | :---: | :---: | :---: | :---: |
| Collector-base voltage (Emitter open) | 2SB0942 | $\mathrm{V}_{\text {CBo }}$ | -60 | V |
|  | 2SB0942A |  | -80 |  |
| Collector-emitter voltage (Base open) | 2SB0942 | $\mathrm{V}_{\text {CEO }}$ | -60 | V |
|  | 2SB0942A |  | -80 |  |
| Emitter-base voltage (Collector open) |  | $\mathrm{V}_{\text {Ebo }}$ | -5 | V |
| Collector current |  | $\mathrm{I}_{\mathrm{C}}$ | -4 | A |
| Peak collector current |  | $\mathrm{I}_{\mathrm{CP}}$ | -8 | A |
| Collector power |  | $\mathrm{P}_{\mathrm{C}}$ | 40 | W |
| dissipation | $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ |  | 2 |  |
| Junction temperature |  | $\mathrm{T}_{\mathrm{j}}$ | 150 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature |  | $\mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |



Electrical Characteristics $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C} \pm 3^{\circ} \mathrm{C}$

| Parameter |  | Symbol | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Collector-emitter voltage (Base open) | 2SB0942 | $\mathrm{V}_{\text {CEO }}$ | $\mathrm{I}_{\mathrm{C}}=-30 \mathrm{~mA}, \mathrm{I}_{\mathrm{B}}=0$ | -60 |  |  | V |
|  | 2SB0942A |  |  | -80 |  |  |  |
| Base-emitter voltage |  | $V_{\text {BE }}$ | $\mathrm{V}_{\mathrm{CE}}=-4 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=-3 \mathrm{~A}$ |  |  | -2 | V |
| Collector-emitter cutoff current (E-B short) | 2SB0942 | $\mathrm{I}_{\text {CES }}$ | $\mathrm{V}_{\mathrm{CE}}=-60 \mathrm{~V}, \mathrm{~V}_{\mathrm{BE}}=0$ |  |  | -400 | $\mu \mathrm{A}$ |
|  | 2SB0942A |  | $\mathrm{V}_{\mathrm{CE}}=-80 \mathrm{~V}, \mathrm{~V}_{\mathrm{BE}}=0$ |  |  | -400 |  |
| Collector-emitter cutoff current (Base open) |  | $\mathrm{I}_{\text {CEO }}$ | $\mathrm{V}_{\mathrm{CE}}=-30 \mathrm{~V}, \mathrm{I}_{\mathrm{B}}=0$ |  |  | -700 | $\mu \mathrm{A}$ |
| Emitter-base cutoff current (Collector open) |  | $\mathrm{I}_{\text {EBO }}$ | $\mathrm{V}_{\mathrm{EB}}=-5 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=0$ |  |  | -1 | mA |
| Forward current transfer ratio |  | $\mathrm{h}_{\mathrm{FE} 1}{ }^{*}$ | $\mathrm{V}_{\mathrm{CE}}=-4 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=-1 \mathrm{~A}$ | 40 |  | 250 | - |
|  |  | $\mathrm{h}_{\text {FE2 }}$ | $\mathrm{V}_{\mathrm{CE}}=-4 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=-3 \mathrm{~A}$ | 15 |  |  |  |
| Collector-emitter saturation voltage |  | $\mathrm{V}_{\mathrm{CE} \text { (sat) }}$ | $\mathrm{I}_{\mathrm{C}}=-4 \mathrm{~A}, \mathrm{I}_{\mathrm{B}}=-0.4 \mathrm{~A}$ |  |  | -1.5 | V |
| Transition frequency |  | $\mathrm{f}_{\mathrm{T}}$ | $\mathrm{V}_{\mathrm{CE}}=-10 \mathrm{~V}, \mathrm{I}_{\mathrm{C}}=-0.1 \mathrm{~A}, \mathrm{f}=10 \mathrm{MHz}$ |  | 30 |  | MHz |
| Turn-on time |  | $\mathrm{t}_{\text {on }}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{C}}=-4 \mathrm{~A}, \mathrm{I}_{\mathrm{B} 1}=-0.4 \mathrm{~A}, \mathrm{I}_{\mathrm{B} 2}=0.4 \mathrm{~A} \\ & \mathrm{~V}_{\mathrm{CC}}=-50 \mathrm{~V} \end{aligned}$ |  | 0.2 |  | $\mu \mathrm{s}$ |
| Storage time |  | $\mathrm{t}_{\text {stg }}$ |  |  | 0.5 |  | $\mu \mathrm{s}$ |
| Fall time |  | $\mathrm{t}_{\mathrm{f}}$ |  |  | 0.2 |  | $\mu \mathrm{s}$ |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.
2. *: Rank classification

| Rank | R | Q | P |
| :---: | :---: | :---: | :---: |
| $\mathrm{h}_{\text {FE1 }}$ | 40 to 90 | 70 to 150 | 120 to 250 |

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$\mathrm{R}_{\mathrm{th}}-\mathrm{t}$


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[^0]:    Note) The part numbers in the parenthesis show conventional part number.

